

1A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	1	А	
V _{RRM}	200 - 1000	V	
I _{FSM}	30	А	
T _{J MAX}	150	°C	
Package	Thin SMA		
Configuration	Single die		



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	S1D	S1G	S1J	S1K	S1M	UNIT
			ALH	ALH	ALH	ALH	ALH	
Marking code on the device			S1DAH	S1GAH	S1JAH	S1KAH	S1MAH	
Repetitive peak reverse voltage		V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		V _{R(RMS)}	140	280	420	560	700	V
Forward current		I _F	1			А		
Surge peak forward current, single half sine-wave	t = 8.3ms		30		А			
superimposed on rated load	t = 1.0ms	IFSM	100				А	
Junction temperature		TJ	-55 to +150			°C		
Storage temperature		T _{STG}	-55 to +150			°C		



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R _{ejl}	29	°C/W	
Junction-to-ambient thermal resistance	R _{eja}	82	°C/W	
Junction-to-case thermal resistance	R _{eJC}	30	°C/W	

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
F actorial and H ange (1)	$I_F = 0.5A, T_J = 25^{\circ}C$		0.90	-	V
	$I_F = 1.0A, T_J = 25^{\circ}C$	V _F	0.96	1.10	V
Forward voltage ⁽¹⁾	$I_F = 0.5A, T_J = 125^{\circ}C$		0.78	-	V
	$I_F = 1.0A, T_J = 125^{\circ}C$		0.85	0.98	V
Reverse current @ rated V _R ⁽²⁾	$T_J = 25^{\circ}C$	- I _R	-	1	μA
	T _J = 125°C		-	50	μA
Junction capacitance	$1 MHz, V_{R} = 4.0 V$	CJ	8	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
S1xALH	Thin SMA	14,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 200V(S1DALH) to 1000V(S1MALH)



f=1.0MHz Vsig=50mVp-p

100

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

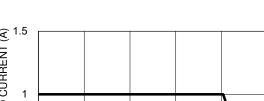


Fig.1 Forward Current Derating Curve

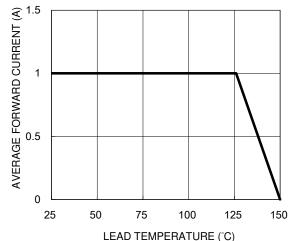
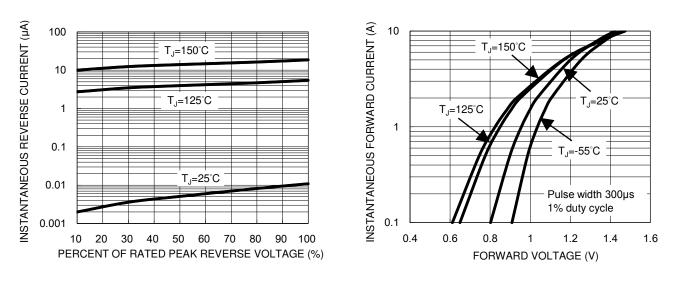


Fig.3 Typical Reverse Characteristics



100

10

1

0.1

1

CAPACITANCE (pF)

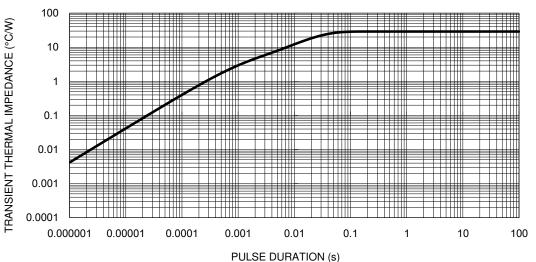


Fig.5 Typical Transient Thermal Impedance

Fig.2 Typical Junction Capacitance

10

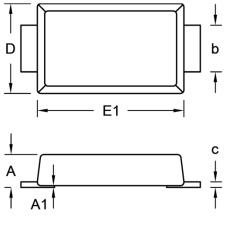
REVERSE VOLTAGE (V)

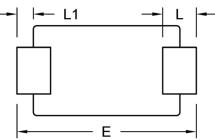
Fig.4 Typical Forward Characteristics



PACKAGE OUTLINE DIMENSIONS

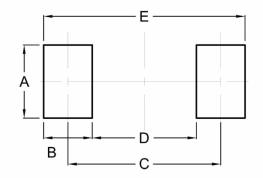






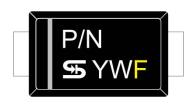
DIM.	Unit	Unit (mm)		(inch)
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
с	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code
F	= Factory Code



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.